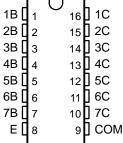
ULN2001A, ULN2002A, ULN2003A, ULN2004A, ULQ2003A, ULQ2004A, HIGH-VOLTAGE HIGH-CURRENT DARLINGTON TRANSISTOR ARRAY

The ULN2001A is obsolete and is no longer supplied.

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- 500-mA Rated Collector Current (Single Output)
- High-Voltage Outputs . . . 50 V
- Output Clamp Diodes
- Inputs Compatible With Various Types of Logic
- Relay Driver Applications
- Designed to Be Interchangeable With Sprague ULN2001A Series
- Package Options Include Plastic Small Outline (D, NS) Packages, and Plastic DIP (N)

ULN2001A . . . D OR N PACKAGE
ULN2002A . . . N PACKAGE
ULN2003A, ULN2004A . . . D, N, OR NS PACKAGE
ULQ2003A, ULQ2004A . . . D PACKAGE
(TOP VIEW)



description

The ULN2001A, ULN2002A, ULN2003A, ULN2004A, ULQ2003A, and ULQ2004A are high-voltage, high-current Darlington transistor arrays. Each consists of seven npn Darlington pairs that feature high-voltage outputs with common-cathode clamp diodes for switching inductive loads. The collector-current rating of a single Darlington pair is 500 mA. The Darlington pairs may be paralleled for higher current capability. Applications include relay drivers, hammer drivers, lamp drivers, display drivers (LED and gas discharge), line drivers, and logic buffers. For 100-V (otherwise interchangeable) versions of the ULN2003A and ULN2004A, see the SN75468 and SN75469, respectively.

The ULN2001A is a general-purpose array and can be used with TTL and CMOS technologies. The ULN2002A is specifically designed for use with 14-V to 25-V PMOS devices. Each input of this device has a zener diode and resistor in series to control the input current to a safe limit. The ULN2003A and ULQ2003A have a 2.7-k Ω series base resistor for each Darlington pair for operation directly with TTL or 5-V CMOS devices. The ULN2004A and ULQ2004A have a 10.5-k Ω series base resistor to allow operation directly from CMOS devices that use supply voltages of 6 V to 15 V. The required input current of the ULN/ULQ2004A is below that of the ULN/ULQ2003A, and the required voltage is less than that required by the ULN2002A.

AVAILABLE OPTIONS

	PACK	AGES
TA	SMALL OUTLINE (D, NS)	PLASTIC DIP (N)
	-	ULN2002AN
–20°C to 70°C	ULN2003AD ULN2003ANS	ULN2003AN
	ULN2004AD ULN2004ANS	ULN2004AN
–40°C to 85°C	ULQ2003AD	_
+0 O 10 00 O	ULQ2004AD	_

The D package is available taped and reeled. Add the suffix R to device type (e.g., ULN2003ADR). The NS package is only available taped and reeled.

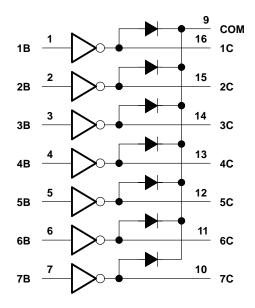


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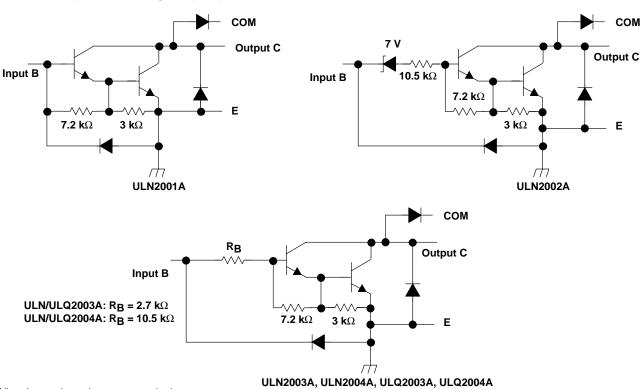


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logic diagram



schematics (each Darlington pair)



All resistor values shown are nominal.

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The ULN2001A is obsolete and is no longer supplied.

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absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)†

Collector-emitter voltage	50 V
Clamp diode reverse voltage (see Note 1)	50 V
Input voltage, V _I (see Note 1)	30 V
Peak collector current (see Figures 14 and 15)	500 mA
Output clamp current, I _{OK}	500 mA
Total emitter-terminal current	
Continuous total power dissipation	See Dissipation Rating Table
Package thermal impedance, θ_{JA} (see Note 2): D package	
N package	67°C/W
NS package	64°C/W
Operating free-air temperature range, T _A , ULN200xA	–20°C to 70°C
ULQ200xA	40°C to 85°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to the emitter/substrate terminal E, unless otherwise noted.
 - 2. The package thermal impedance is calculated in accordance with JESD 51-7.

DISSIPATION RATING TABLE

PACKAGE	T _A = 25°C POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 85°C POWER RATING
D	950 mW	7.6 mW/°C	494 mW
N	1150 mW	9.2 mW/°C	598 mW

electrical characteristics, T_A = 25°C (unless otherwise noted)

	PARAMETER	TEST	TEST CO	TEST CONDITIONS		N2001	4	UI	N2002	١	UNIT				
	PARAMETER	FIGURE	TEST CONDITIONS -		MIN	TYP	MAX	MIN	TYP	MAX	UNII				
V _{I(on)}	On-state input voltage	6	V _{CE} = 2 V,	$I_C = 300 \text{ mA}$						13	V				
	.		$I_I = 250 \mu A$,	$I_C = 100 \text{ mA}$		0.9	1.1		0.9	1.1					
VCE(sat)	Collector-emitter saturation voltage	5	$I_I = 350 \mu A$,	$I_C = 200 \text{ mA}$		1	1.3		1	1.3	V				
	cataration voltage		$I_I = 500 \mu A$,	$I_C = 350 \text{ mA}$		1.2	1.6		1.2	1.6					
٧F	Clamp forward voltage	8	$I_F = 350 \text{ mA}$			1.7	2		1.7	2	V				
		1	V _{CE} = 50 V,	I _I = 0			50			50					
ICEX	Collector cutoff current	2	V _{CE} = 50 V,	I _I = 0			100			100	μΑ				
			T _A = 70°C	T _A = 70°C	$T_A = 70^{\circ}C$	T _A = 70°C	T _A = 70°C	V _I = 6 V						500	
II(off)	Off-state input current	3	V _{CE} = 50 V, T _A = 70°C	$I_C = 500 \mu A$,	50	65		50	65		μΑ				
IĮ	Input current	4	V _I = 17 V						0.82	1.25	mA				
	Olama marrama arramant	7	$V_R = 50 V$,	T _A = 70°C			100			100	^				
^I R	Clamp reverse current	′ [V _R = 50 V		-		50			50	μΑ				
hFE	Static forward current transfer ratio	5	V _{CE} = 2 V,	I _C = 350 mA	1000										
Ci	Input capacitance		$V_{I} = 0$,	f = 1 MHz		15	25		15	25	pF				



ULN2001A, ULN2002A, ULN2003A, ULN2004A, ULQ2003A, ULQ2004A, HIGH-VOLTAGE HIGH-CURRENT DARLINGTON

TRANSISTOR ARRAY

The ULN2001A is obsolete and is no longer supplied.

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electrical characteristics, $T_A = 25^{\circ}C$ (unless otherwise noted)

PARAMETER		TEST	TEST CONDITIONS		UI	_N2003	4	ULN2004A			UNIT
	PARAMETER	FIGURE	l lesi co	TEST CONDITIONS		TYP	MAX	MIN	TYP	MAX	UNII
				$I_C = 125 \text{ mA}$						5	
				I _C = 200 mA			2.4			6	
	On atota innut valtage	6	V 2.V	I _C = 250 mA			2.7				V
V _{I(on)}	On-state input voltage	0	V _{CE} = 2 V	$I_C = 275 \text{ mA}$						7	V
				$I_C = 300 \text{ mA}$			3				
				$I_C = 350 \text{ mA}$						8	
	0.11.4		$I_{\parallel} = 250 \mu A$,	$I_C = 100 \text{ mA}$		0.9	1.1		0.9	1.1	
VCE(sat)	Collector-emitter saturation voltage	5	$I_{I} = 350 \mu A$,	$I_C = 200 \text{ mA}$		1	1.3		1	1.3	V
	odiaration voltago		$I_I = 500 \mu A$,	$I_C = 350 \text{ mA}$		1.2	1.6		1.2	1.6	
		1	V _{CE} = 50 V,	I _I = 0			50			50	
ICEX	Collector cutoff current	2	V _{CE} = 50 V,	I _I = 0			100			100	μΑ
		2	T _A = 70°C	V _I = 1 V						500	
٧F	Clamp forward voltage	8	$I_F = 350 \text{ mA}$			1.7	2		1.7	2	V
I _{I(off)}	Off-state input current	3	V _{CE} = 50 V, T _A = 70°C	$I_C = 500 \mu A$,	50	65		50	65		μΑ
			V _I = 3.85 V			0.93	1.35				
lį	Input current	4	V _I = 5 V						0.35	0.5	mA
			V _I = 12 V						1	1.45	
la.	Clomp roveree ourrest	7	V _R = 50 V				50			50	
^I R	Clamp reverse current		$V_R = 50 V$,	T _A = 70°C			100			100	μΑ
Ci	Input capacitance		V _I = 0,	f = 1 MHz		15	25		15	25	pF

ULN2001A, ULN2002A, ULN2003A, ULN2004A, ULQ2003A, ULQ2004A, HIGH-VOLTAGE HIGH-CURRENT DARLINGTON TRANSISTOR ARRAY

The ULN2001A is obsolete and is no longer supplied.

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electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST	TEST CO.	NDITIONS	UL	Q2003	4	ULQ2004A			UNIT						
		FIGURE	TEST CONDITIONS		MIN	TYP	MAX	MIN	TYP	MAX	ONIT						
				$I_C = 125 \text{ mA}$						5							
				I _C = 200 mA			2.7			6							
	On atota innut valtage	6	V 2.V	I _C = 250 mA			2.9				٧						
V _{I(on)}	On-state input voltage	б	V _{CE} = 2 V	I _C = 275 mA						7	V						
				IC = 300 mA			3										
				I _C = 350 mA						8							
	0 II III		$I_{I} = 250 \mu A$,	$I_C = 100 \text{ mA}$		0.9	1.2		0.9	1.1							
VCE(sat)	Collector-emitter saturation voltage	5	5	$I_I = 350 \mu A$,	$I_C = 200 \text{ mA}$		1	1.4		1	1.3	V					
	odidiation voltage			$I_{I} = 500 \mu A$,	$I_C = 350 \text{ mA}$		1.2	1.7		1.2	1.6						
		1	V _{CE} = 50 V,	I _I = 0			100			50							
ICEX	Collector cutoff current	2	V _{CE} = 50 V	I _I = 0						100	μΑ						
		2		vCE = 20 v	VCE = 30 V	VCE = 30 V	VCE = 50 V	VCE = 20 V	VCE - 30 V	VCE - 30 V	V _I = 1 V						500
٧F	Clamp forward voltage	8	$I_F = 350 \text{ mA}$			1.7	2.2		1.7	2	V						
I(off)	Off-state input current	3	V _{CE} = 50 V,	I _C = 500 μA	30	65		50	65		μΑ						
			V _I = 3.85 V			0.93	1.35										
l _l	Input current	4	V _I = 5 V						0.35	0.5	mA						
			V _I = 12 V						1	1.45							
	Clamp rayaraa ayrra-t	7	$V_R = 50 V$,	T _A = 25°C			100			50							
^I R	Clamp reverse current	7	V _R = 50 V				100			100	μΑ						
Ci	Input capacitance		V _I = 0,	f = 1 MHz		15	25		15	25	pF						

switching characteristics, $T_A = 25^{\circ}C$

PARAMETER		TEST CONDITIONS	ULN2001 ULN2003	UNIT		
			MIN	TYP	MAX	
tPLH	Propagation delay time, low-to-high-level output	See Figure 9		0.25	1	μs
tPHL	Propagation delay time, high-to-low-level output	See rigule 9		0.25	1	μs
Vон	High-level output voltage after switching	$V_S = 50 \text{ V}, \qquad I_O \approx 300 \text{ mA},$ See Figure 10	V _S -20			mV

switching characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	ULQ2003	UNIT		
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	Propagation delay time, low-to-high-level output	See Figure 9		1	10	μs
tPHL	Propagation delay time, high-to-low-level output	See rigule 9		1	10	μs
Vон	High-level output voltage after switching	$V_S = 50 \text{ V}, \qquad I_O \approx 300 \text{ mA},$ See Figure 10	V _S -500			mV



PARAMETER MEASUREMENT INFORMATION

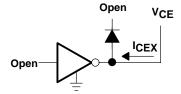


Figure 1. I_{CEX} Test Circuit

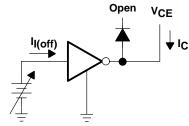
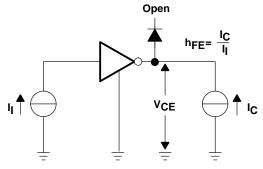


Figure 3. I_{I(off)} Test Circuit



NOTE: I_I is fixed for measuring $V_{\text{CE(sat)}}$, variable for measuring h_{FE}.

Figure 5. h_{FE}, V_{CE(sat)} Test Circuit

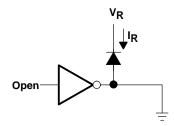


Figure 7. I_R Test Circuit

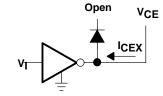


Figure 2. I_{CEX} Test Circuit

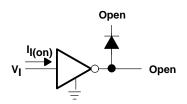


Figure 4. I_I Test Circuit

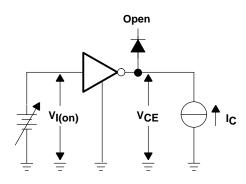


Figure 6. V_{I(on)} Test Circuit

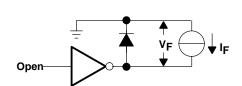


Figure 8. V_F Test Circuit

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PARAMETER MEASUREMENT INFORMATION

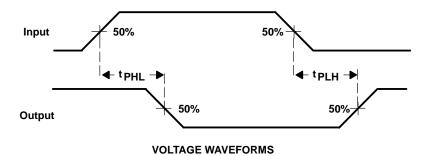
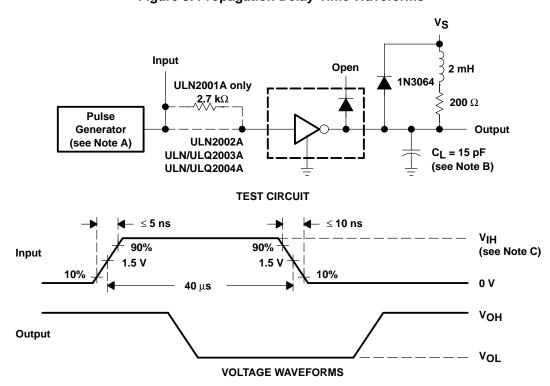


Figure 9. Propagation Delay-Time Waveforms



NOTES: A. The pulse generator has the following characteristics: PRR = 12.5 kHz, $Z_O = 50 \Omega$.

- B. C_L includes probe and jig capacitance.
- C. For testing the ULN2001A, the ULN2003A, and the ULQ2003A, V_{IH} = 3 V; for the ULN2002A, V_{IH} = 13 V; for the ULN2004A and the ULQ2004A, V_{IH} = 8 V.

Figure 10. Latch-Up Test Circuit and Voltage Waveforms

0

100

200

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TYPICAL CHARACTERISTICS

COLLECTOR-EMITTER SATURATION VOLTAGE COLLECTOR CURRENT (ONE DARLINGTON)

2.5 VCE(sat) - Collector-Emitter Saturation Voltage - V T_A = 25°C 2 $I_{I} = 250 \mu A$ $I_1 = 350 \mu A$ $I_i = 500 \mu A$ 1.5 1 0.5

300

400

IC - Collector Current - mA Figure 11

500

600

700

800

COLLECTOR-EMITTER SATURATION VOLTAGE TOTAL COLLECTOR CURRENT (TWO DARLINGTONS PARALLELED)

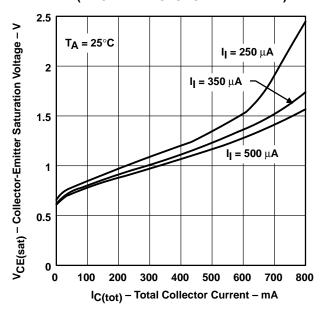


Figure 12

COLLECTOR CURRENT

INPUT CURRENT 500 $R_L = 10 \Omega$ 450 $T_A = 25^{\circ}C$ Collector Current - mA 400 V_S = 10 V 350 V_S = 8 V 300 250 200 150 100 50 0 25 75 100 125 150 200 0 50 175

Figure 13

I_I - Input Current - μA



THERMAL INFORMATION

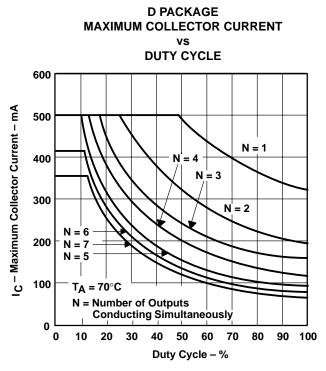


Figure 14

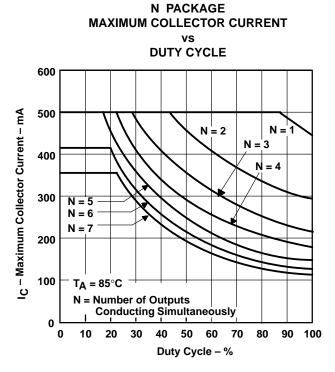


Figure 15

APPLICATION INFORMATION

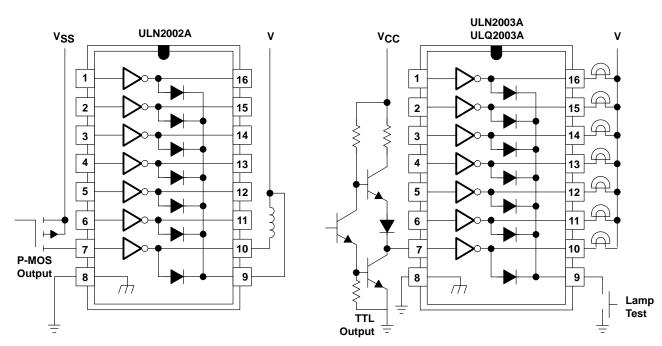


Figure 16. P-MOS to Load

Figure 17. TTL to Load

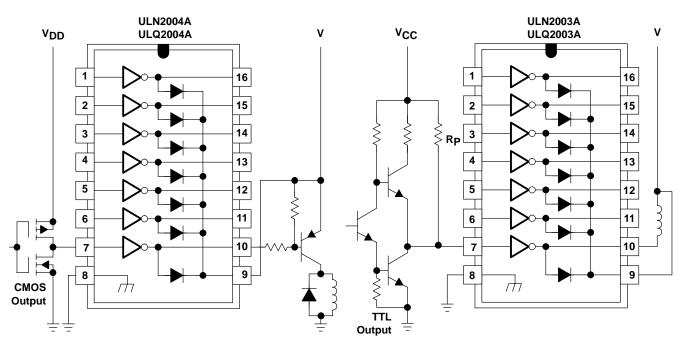


Figure 18. Buffer for Higher Current Loads

Figure 19. Use of Pullup Resistors to Increase Drive Current



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